



高端电力电子器件和装置制造商

**CSG20H2500**

门极可关断晶闸管

**特性**

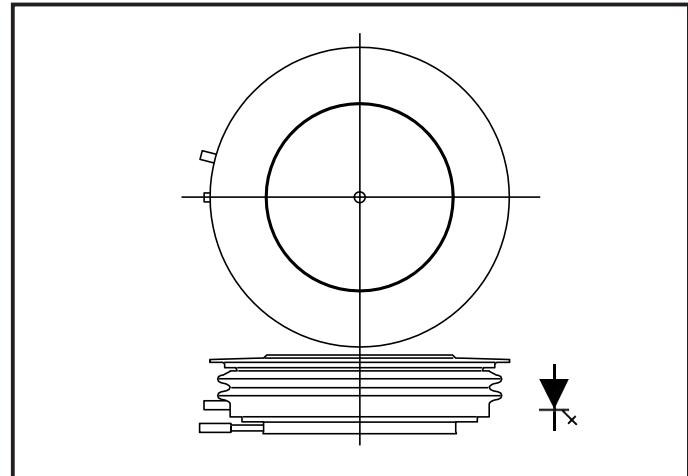
- 双面散热
- 高压性能
- 无快熔故障保护
- 大浪涌电流性能
- 关断性能可减少设备尺寸和重量，环保低噪音

**关键参数**

$V_{DRM}$	<b>2500V</b>
$I_{T(AV)}$	<b>830A</b>
$I_{TGQM}$	<b>2000A</b>
$dI_T/dt$	<b>300A/<math>\mu</math>s</b>

**应用**

- 变速交流电机驱动逆变器(VSD-AC)
- 高电压转换器
- 斩波器
- DC / DC 转换器



Outline type code: H.  
See Package Details for further information.

**电压等级**

型号	断态重复峰值电压 $V_{DRM}$ (V)	反向重复峰值电压 $V_{RRM}$ (V)	测试条件
CSG20H2500	2500	17	$T_{vj} = 125^{\circ}\text{C}$ , $I_{DM} = 50\text{mA}$ , $I_{RRM} = 50\text{mA}$

**电流等级**

符号	参数	测试条件	Max.	单位
$I_{TGQM}$	Repetitive peak controllable on-state current	$V_D = V_{DRM}$ , $T_j = 125^{\circ}\text{C}$ , $dI_{GQ}/dt = 40\text{A}/\text{s}$ , $C_S = 6.0 \text{ F}$	2000	A
$I_{T(AV)}$	Mean on-state current	$T_{HS} = 80^{\circ}\text{C}$ , Double side cooled. Half sine 50Hz	830	A
$I_{T(RMS)}$	RMS on-state current	$T_{HS} = 80^{\circ}\text{C}$ , Double side cooled. Half sine 50Hz	1300	A

## 浪涌等级

符号	参数	测试条件	Max.	单位
$I_{TSM}$	Surge (non repetitive) on-state current	10ms half sine. $T_j = 125^\circ C$	16.0	kA
$I^2t$	$I^2t$ for fusing	10ms half sine. $T_j = 125^\circ C$	1.28	MA <sup>2</sup> s
$di_T/dt$	Critical rate of rise of on-state current	$V_D = 1500V$ , $I_T = 2000A$ , $T_j = 125^\circ C$ , $I_{FG} > 30A$ , Rise time > 1.0μs	300	A/μs
$L_s$	Peak stray inductance in snubber circuit	$I_T = 2000A$ , $V_{DM} = 2500V$ , $T_j = 125^\circ C$ , $di_{GQ}/dt = 40A/\mu s$ , $C_s = 2.0 \mu F$	200	nH

## 门极等级

符号	参数	测试条件	Min.	Max.	单位
$V_{RGM}$	Peak reverse gate voltage	This value may be exceeded during turn-off	-	17	V
$I_{FGM}$	Peak forward gate current		20	100	A
$P_{FG(AV)}$	Average forward gate power		-	15	W
$P_{RGM}$	Peak reverse gate power		-	19	kW
$di_{GQ}/dt$	Rate of rise of reverse gate current		30	60	A/ μs
$t_{ON(min)}$	Minimum permissible on time		50	80	μs
$t_{OFF(min)}$	Minimum permissible off time		80	100	μs

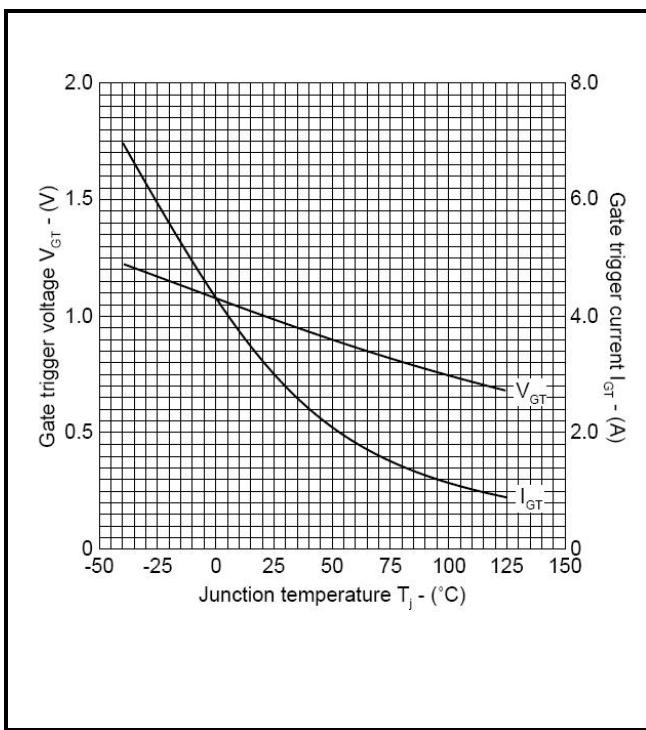
## 热学&力学参数

符号	参数	测试条件		Min.	Max.	单位
$R_{th(j-hs)}$	Thermal resistance – junction to heatsink surface	Double side cooled	DC	-	0.018	°C/W
		Single side cooled	Anode DC	-	0.03	°C/W
			Cathode DC	-	0.045	°C/W
$R_{th(c-hs)}$	Contact thermal resistance	Clamping force 20.0kN With mounting compound	Per contact	-	0.006	°C/W
$T_{vj}$	Virtual junction temperature	On-state (conducting)		-	125	°C
$T_{OP/T_{stg}}$	Operating junction/storage temperature range			-40	125	°C
$F_m$	Clamping force			18.0	22.0	kN

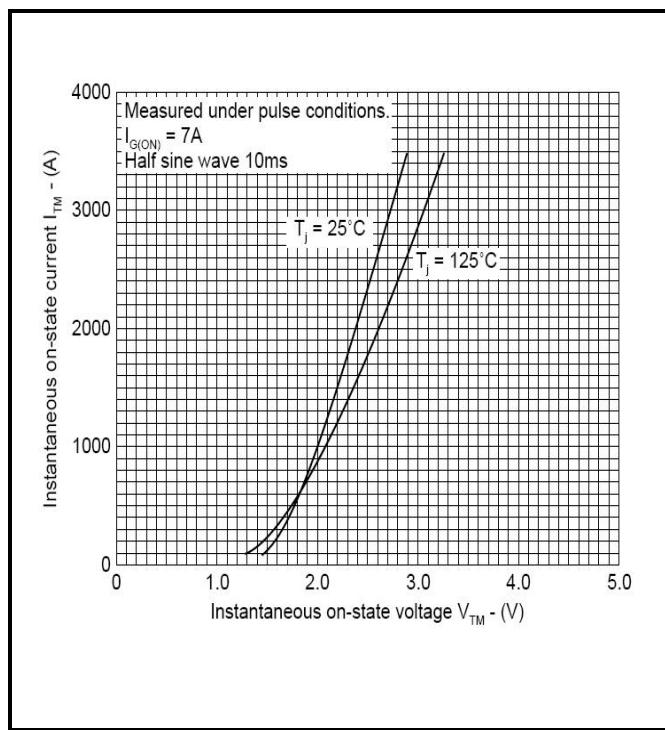
## 特性

$T_j = 125^\circ\text{C}$  unless stated otherwise

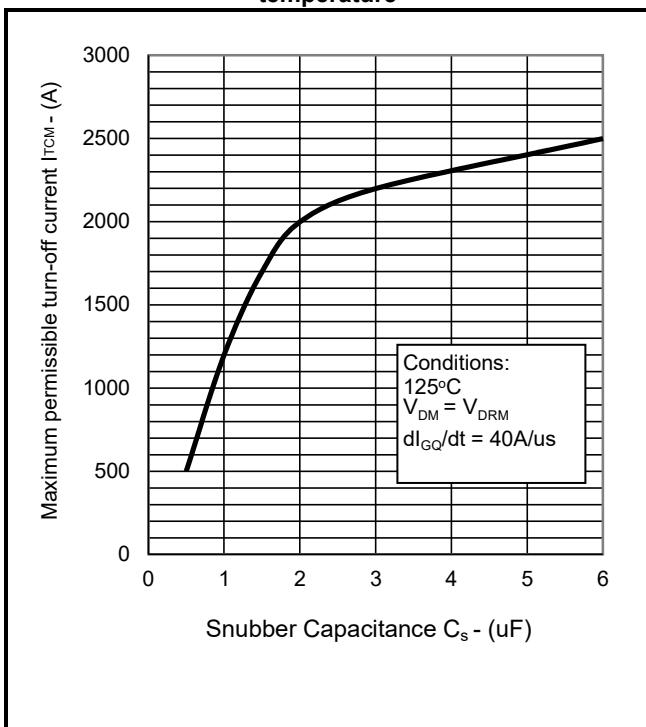
Symbol	Parameter	Test Conditions	Min	Max.	Units
$V_{TM}$	On-state voltage	At 2000A peak, $I_{G(ON)} = 7\text{A dc}$	-	2.8	V
$I_{DM}$	Peak off-state current	$V_{DRM} = 2500\text{V}$ , $V_{RG} = 2\text{V}$	-	30	mA
$I_{RRM}$	Peak reverse current	At $V_{RRM}$	-	50	mA
$V_{GT}$	Gate trigger voltage	$V_D = 24\text{V}$ , $I_T = 100\text{A}$ , $T_j = 25^\circ\text{C}$	-	1.0	V
$I_{GT}$	Gate trigger current	$V_D = 24\text{V}$ , $I_T = 100\text{A}$ , $T_j = 25^\circ\text{C}$	-	2.5	A
$I_{RGM}$	Reverse gate cathode current	$V_{RGM} = 16\text{V}$ , No gate/cathode resistor	-	50	mA
$E_{ON}$	Turn-on energy	$V_D = 1500\text{V}$ $I_T = 2000\text{A}$ , $dI_T/dt = 300\text{A}/\mu\text{s}$ $I_{FG} = 30\text{A}$ , rise time < 1.0 $\mu\text{s}$	-	1188	mJ
$t_d$	Delay time		-	1.5	$\mu\text{s}$
$t_r$	Rise time		-	3.5	$\mu\text{s}$
$E_{OFF}$	Turn-off energy	$I_T = 2000\text{A}$ , $V_{DM} = 2500\text{V}$ , Snubber capacitor $C_S = 2.0 \mu\text{F}$ , $di_{GO}/dt = 40\text{A}/\mu\text{s}$	-	3500	mJ
$t_{gs}$	Storage time		-	22.0	$\mu\text{s}$
$t_{gf}$	Fall time		-	2.0	$\mu\text{s}$
$t_{gq}$	Gate controlled turn-off time		-	19.0	$\mu\text{s}$
$Q_{GQ}$	Turn-off gate charge		-	6600	$\mu\text{C}$
$Q_{GQT}$	Total turn-off gate charge		-	13200	$\mu\text{C}$
$I_{GQM}$	Peak reverse gate current		-	700	A



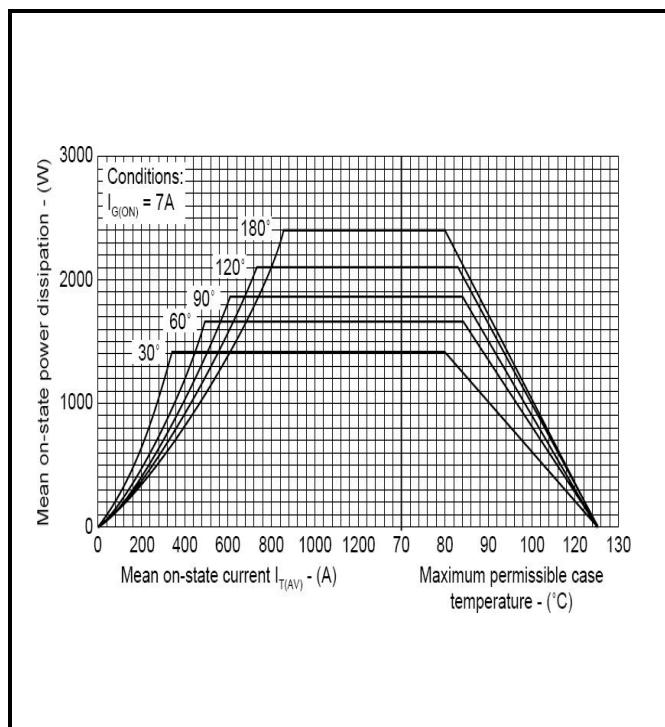
**Fig.1 Maximum gate trigger voltage/current vs junction temperature**



**Fig.2 On-state characteristics**



**Fig.3 Maximum dependence of  $I_{TCM}$  on  $C_s$**



**Fig.4 Steady state sinusoidal wave conduction loss – double side cooled**

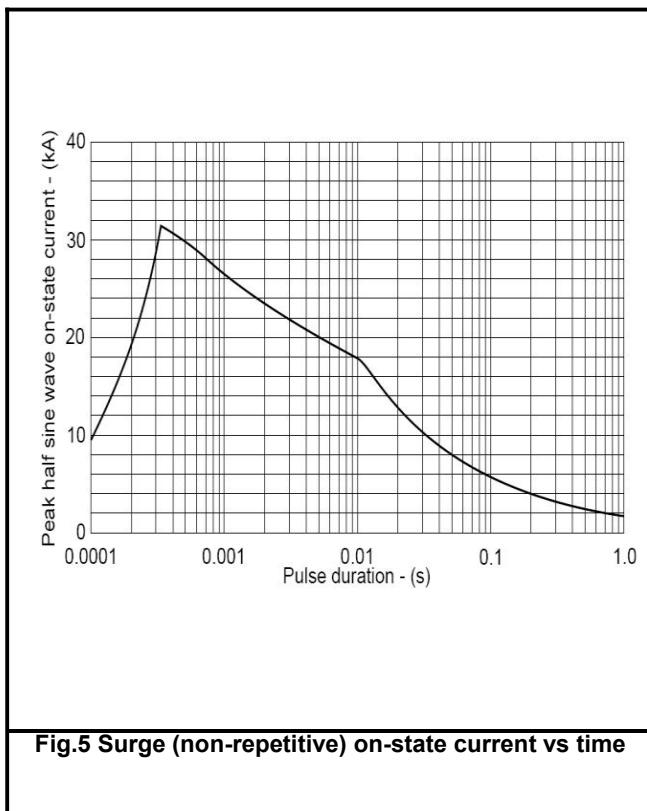


Fig.5 Surge (non-repetitive) on-state current vs time

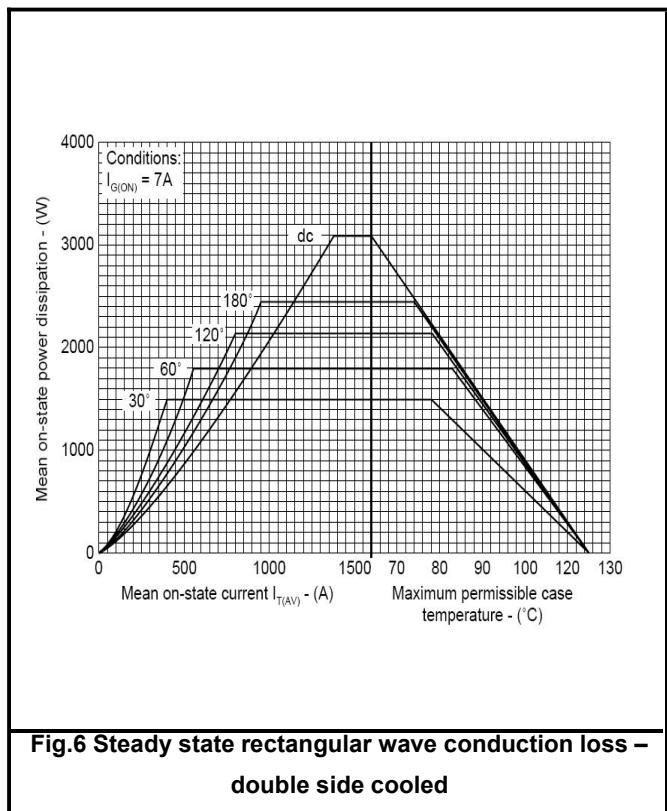


Fig.6 Steady state rectangular wave conduction loss – double side cooled

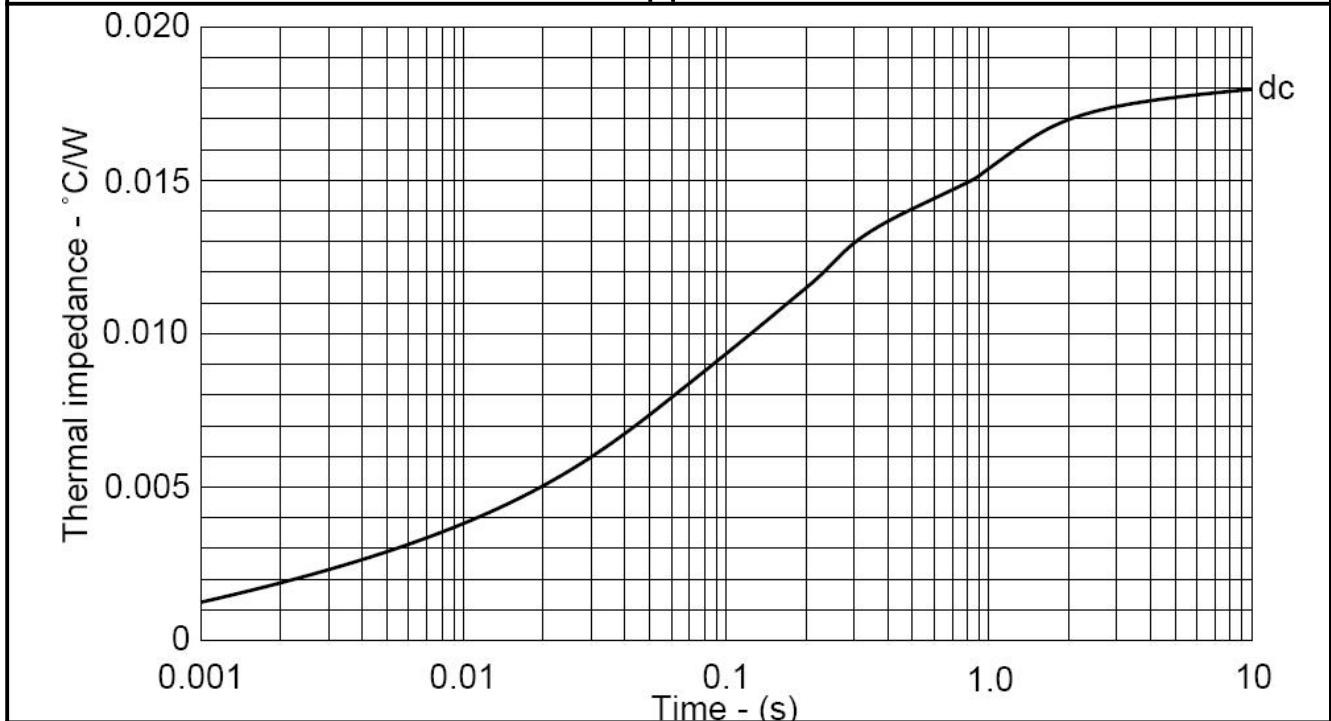


Fig.7 Maximum (limit) transient thermal impedance – junction to case (°C/kW)

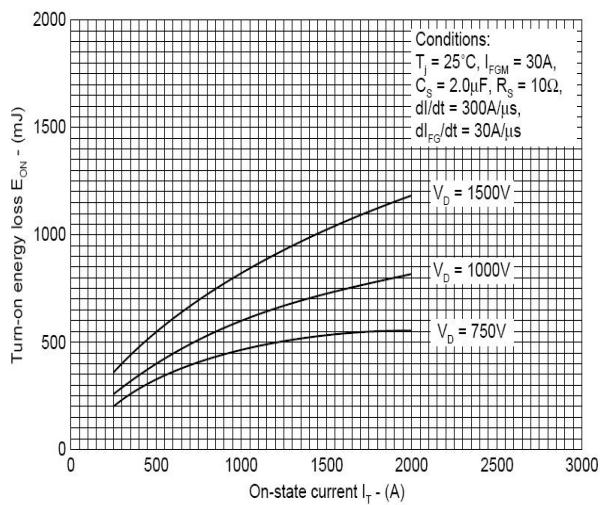


Fig.8 Turn-on energy vs on-state current

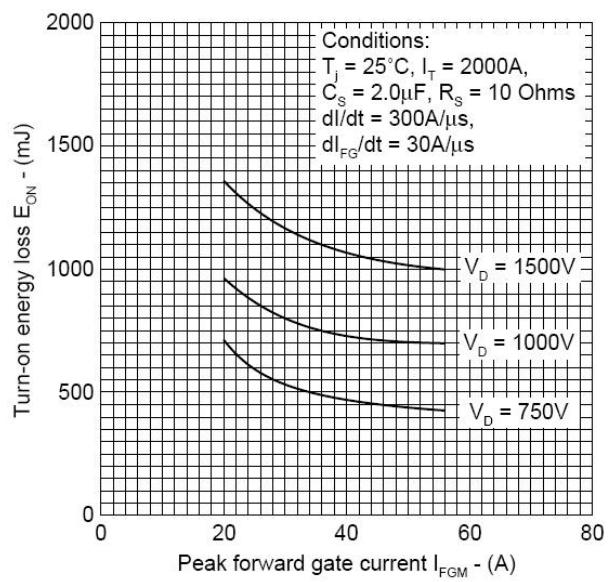


Fig.9 Turn-on energy vs peak forward gate current

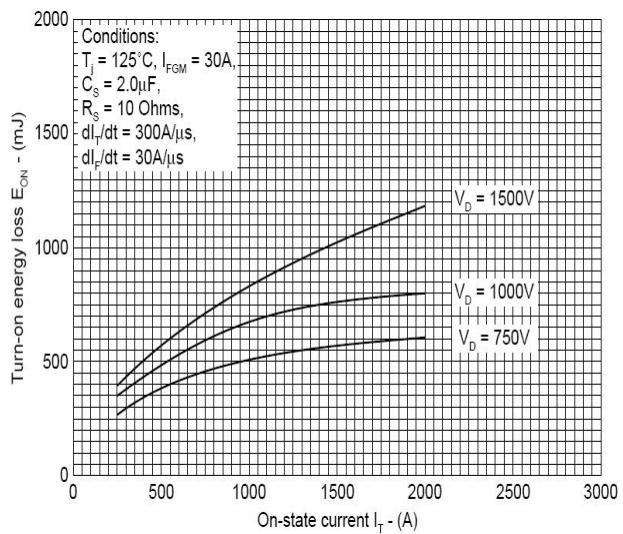


Fig.10 Turn-on energy vs on-state current

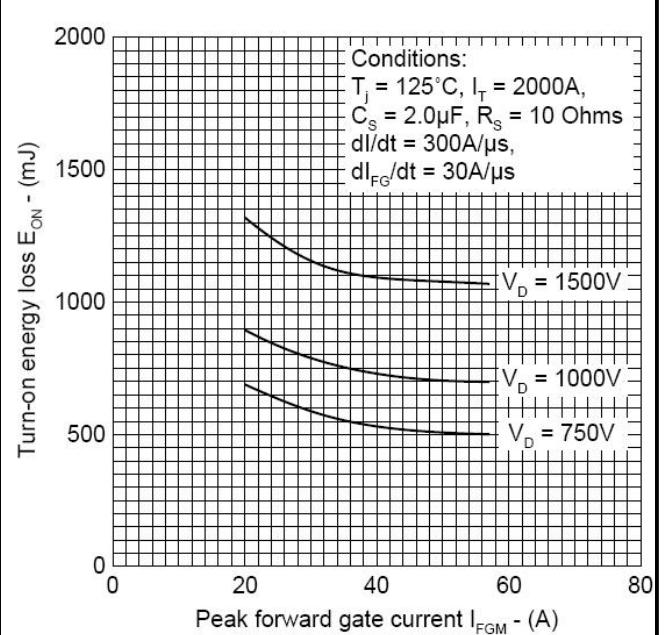


Fig.11 Turn-on energy vs peak forward gate current

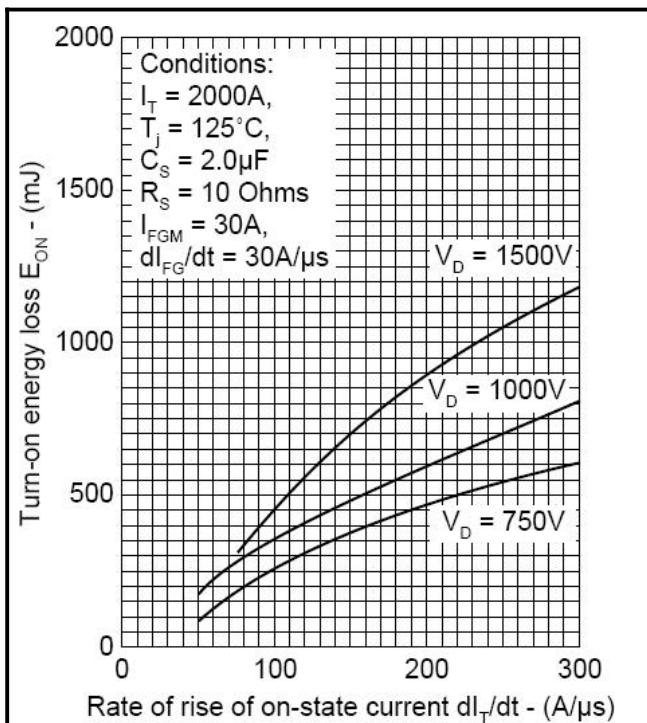


Fig.12 Turn-on energy vs rate of rise of on-state current

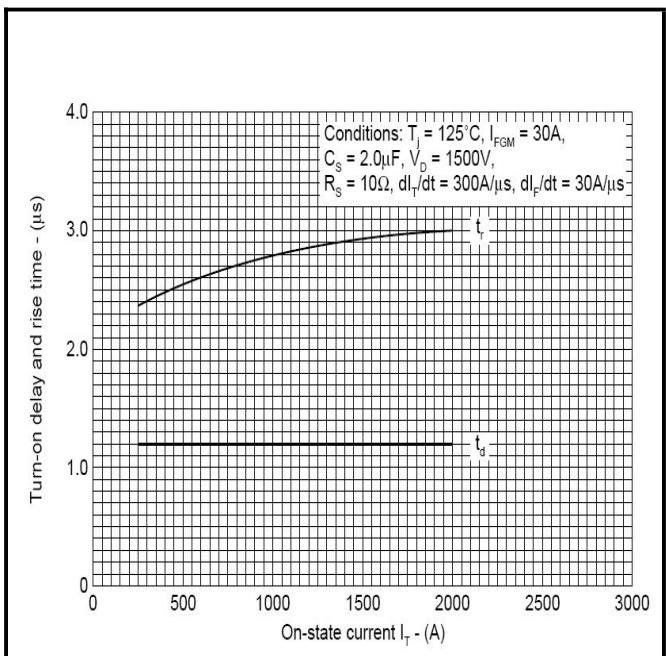


Fig.13 Delay time & rise time vs turn-on current

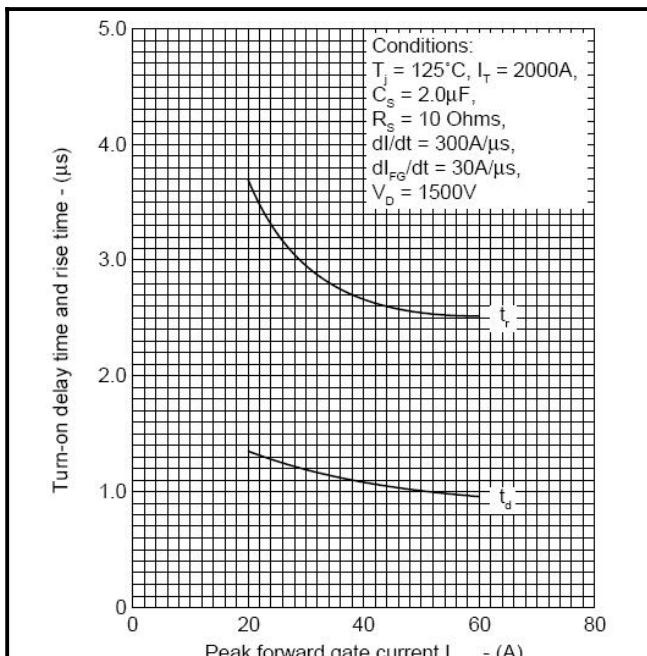


Fig.14 Delay time & rise time vs peak forward gate current

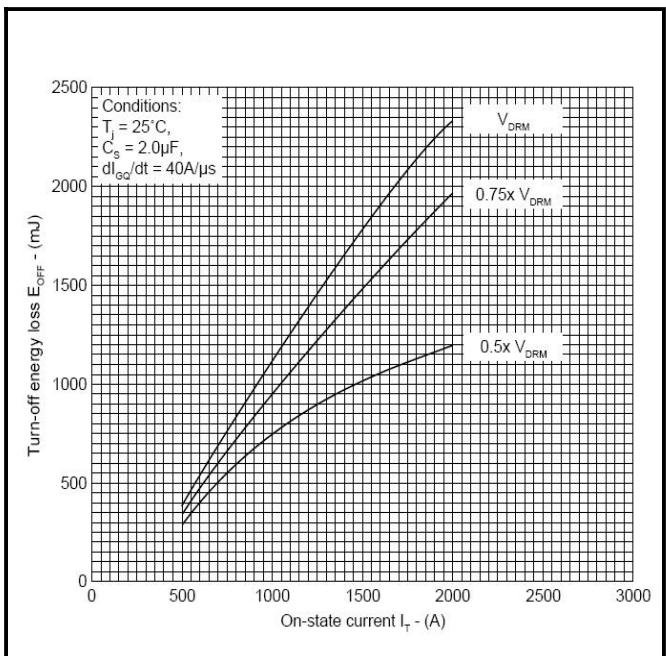


Fig.15 Turn-off energy vs on-state current

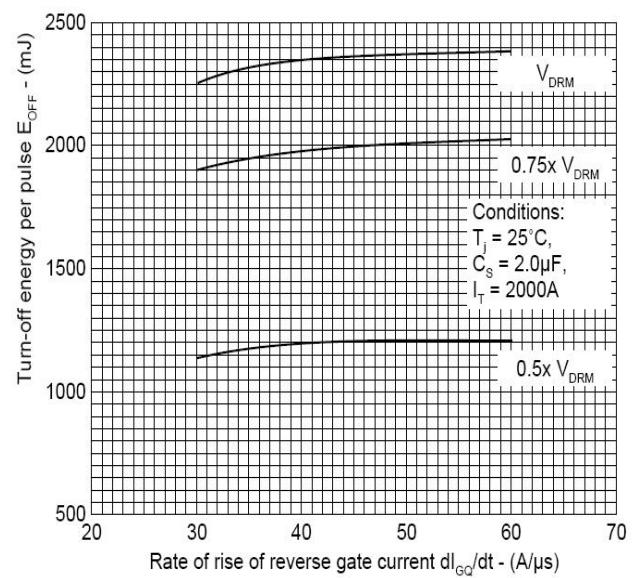


Fig.16 Turn-off energy vs rate of rise of reverse gate current

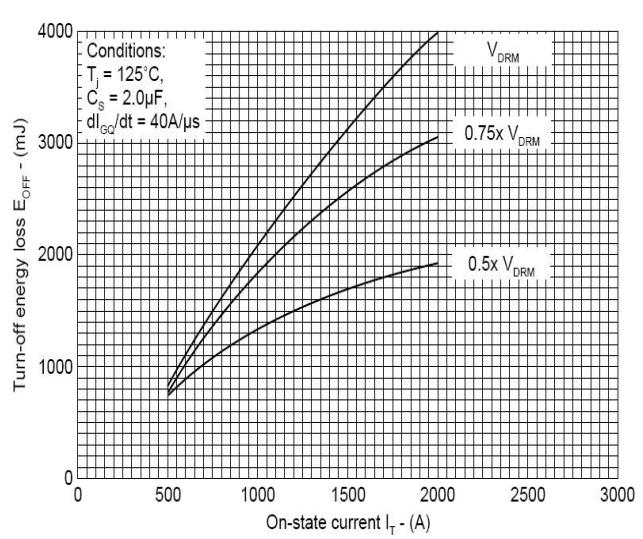


Fig.17 Turn-off energy vs on-state current

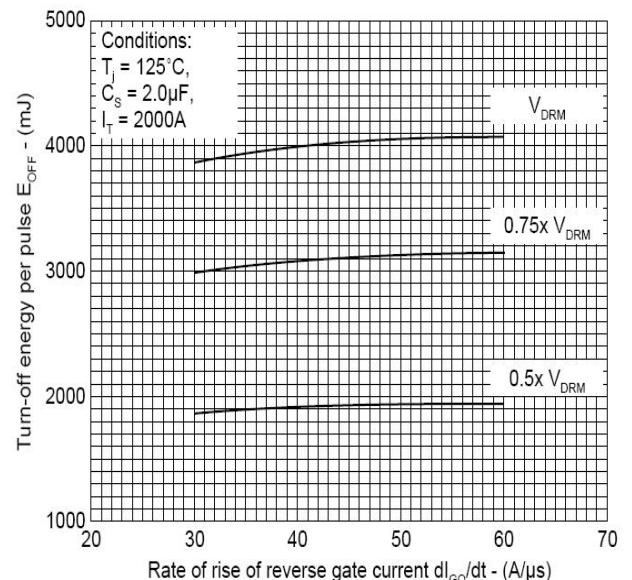


Fig.18 Turn-off energy vs rate of rise of reverse gate current

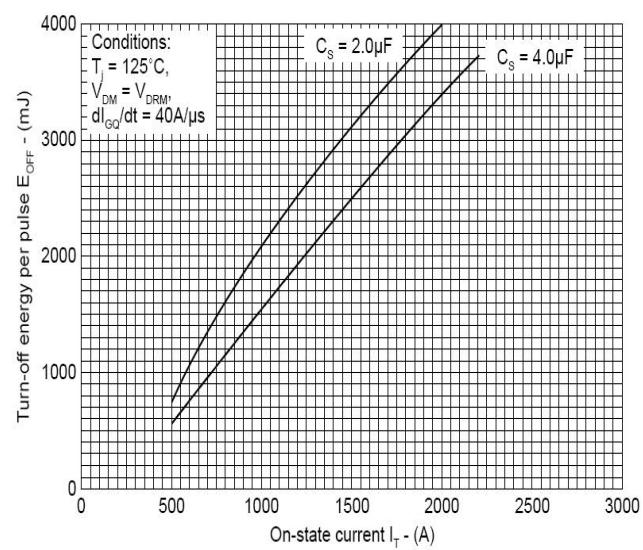


Fig.19 Turn-off energy vs on-state current

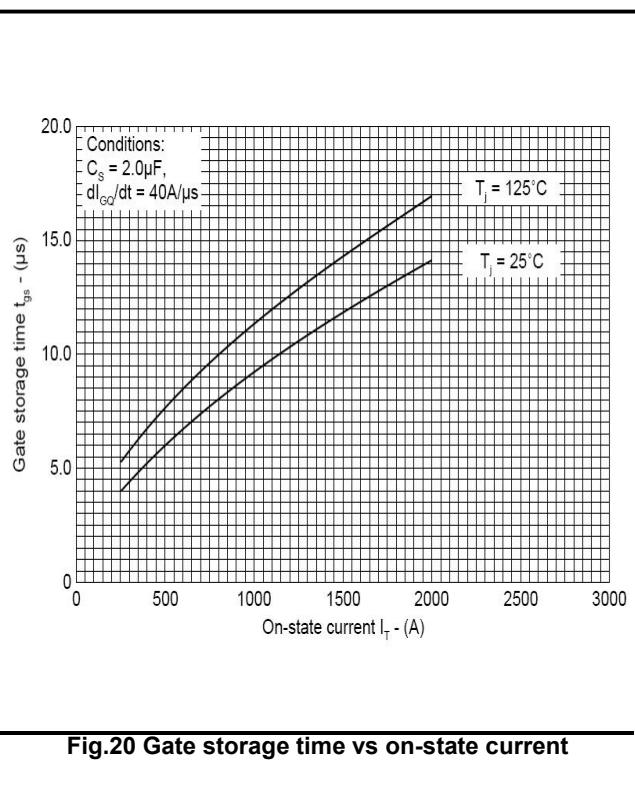


Fig.20 Gate storage time vs on-state current

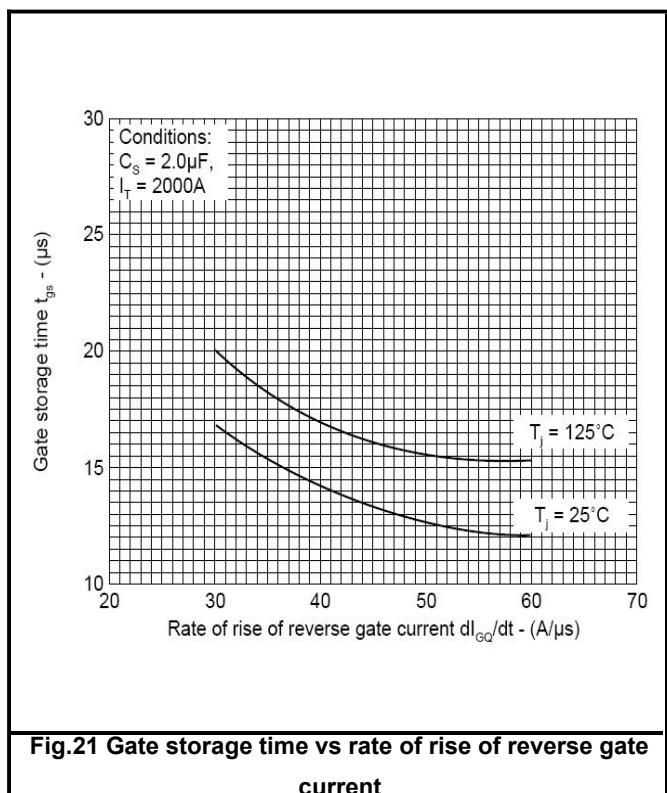


Fig.21 Gate storage time vs rate of rise of reverse gate current

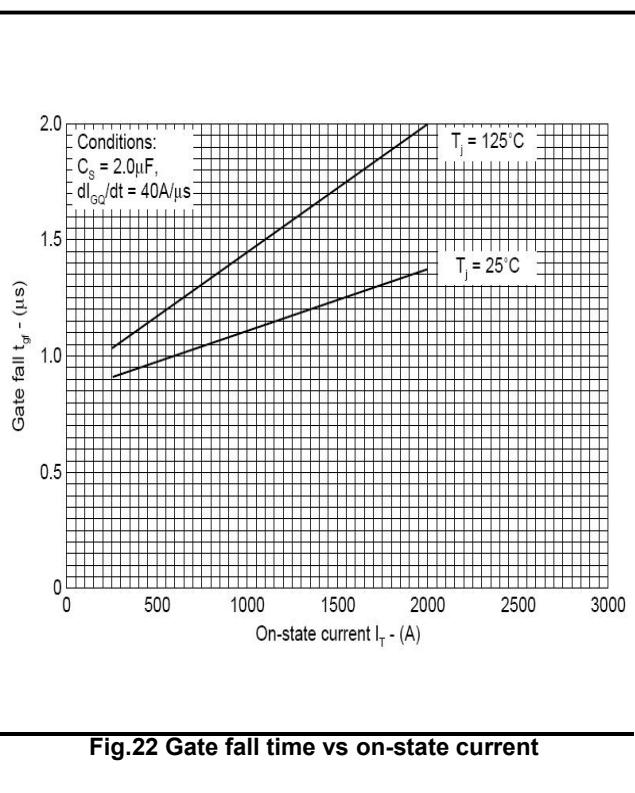


Fig.22 Gate fall time vs on-state current

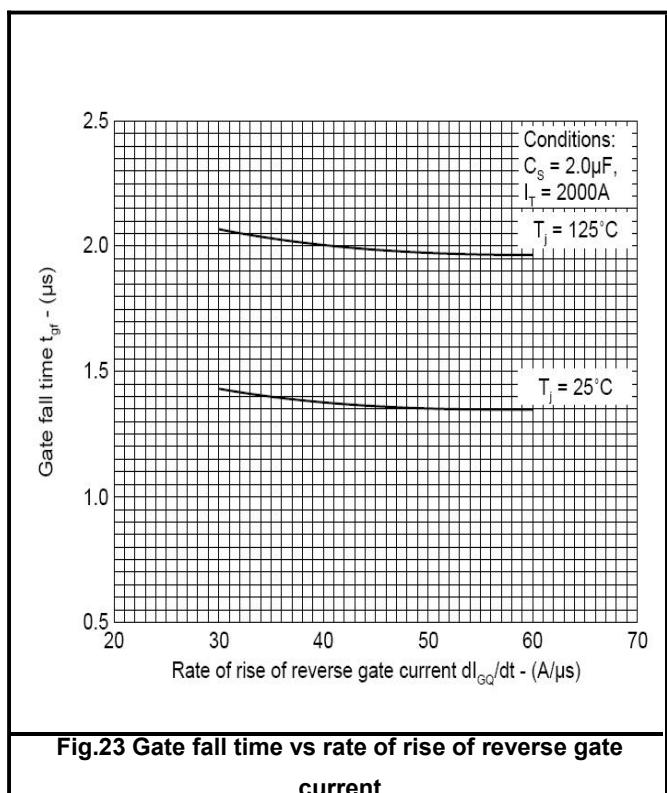


Fig.23 Gate fall time vs rate of rise of reverse gate current

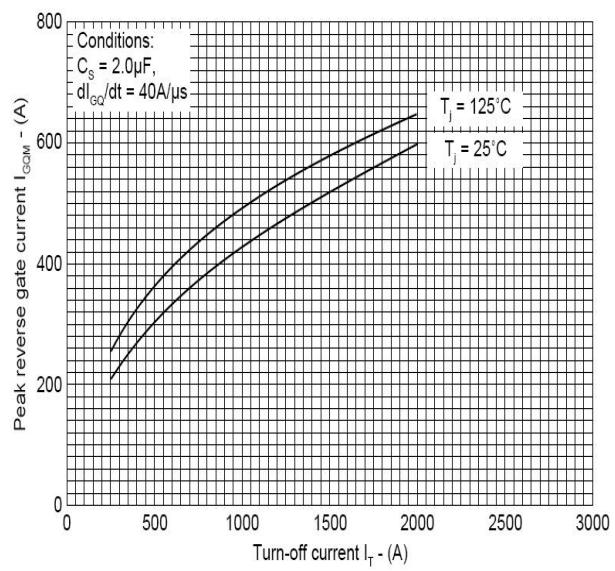


Fig.24 Peak reverse gate current vs turn-off current

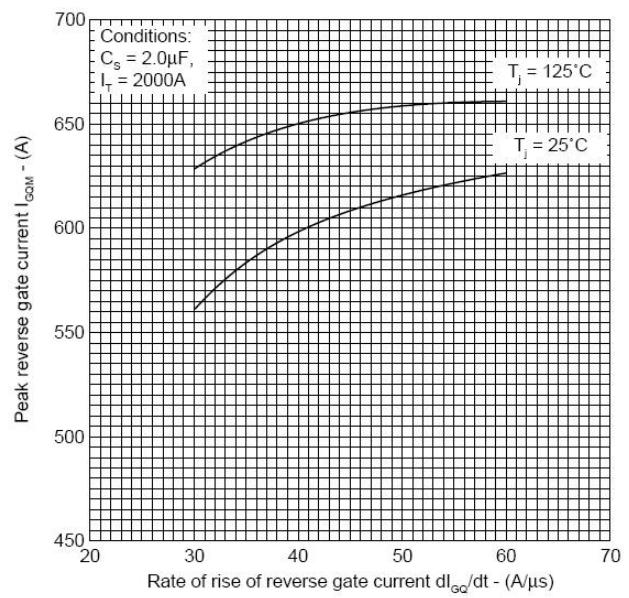


Fig.25 Peak reverse gate current vs rate of rise of reverse gate current

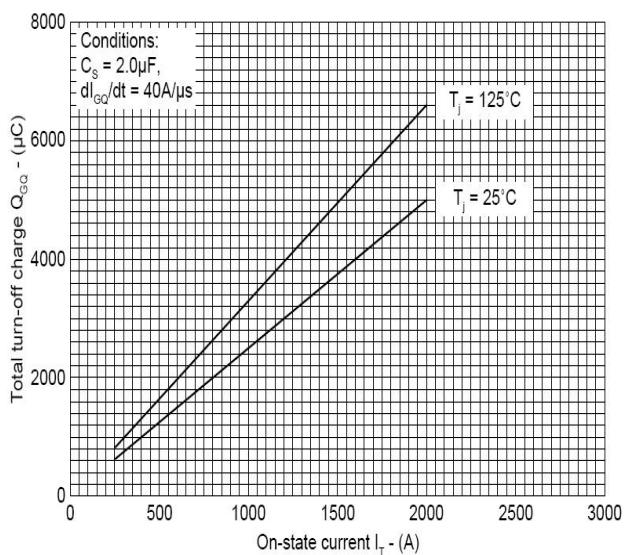


Fig.26 Turn-off gate charge vs on-state current

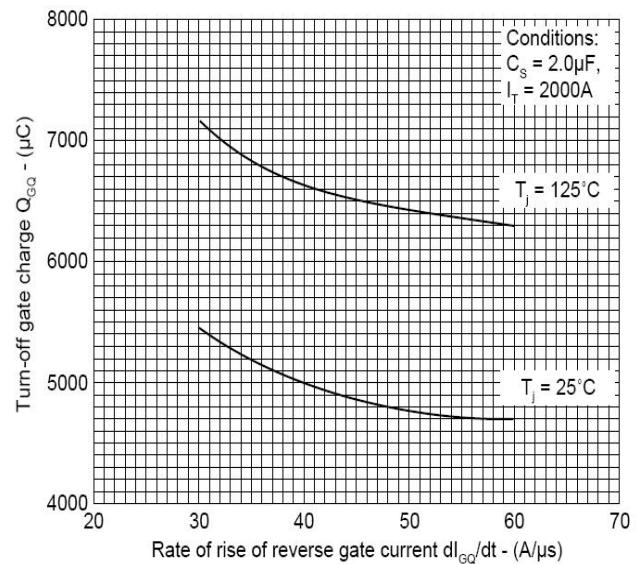


Fig.27 Turn-off gate charge vs rate of rise of reverse gate current

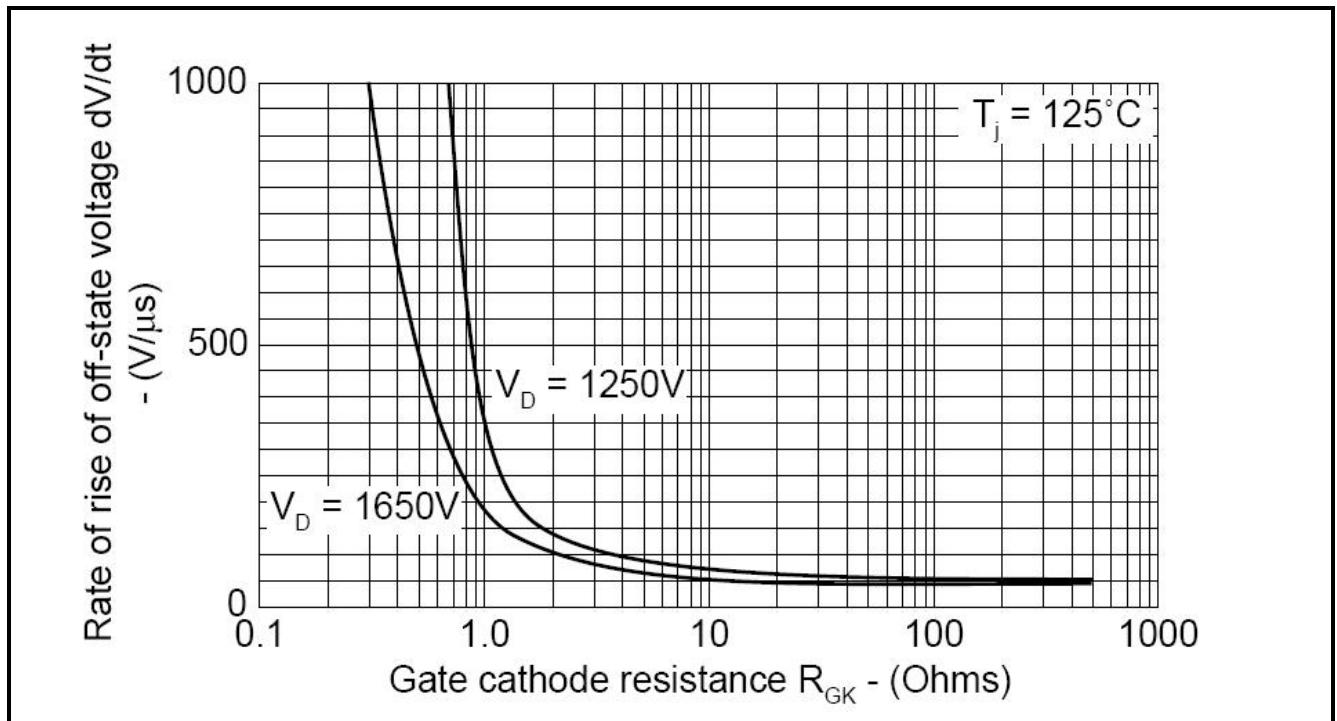
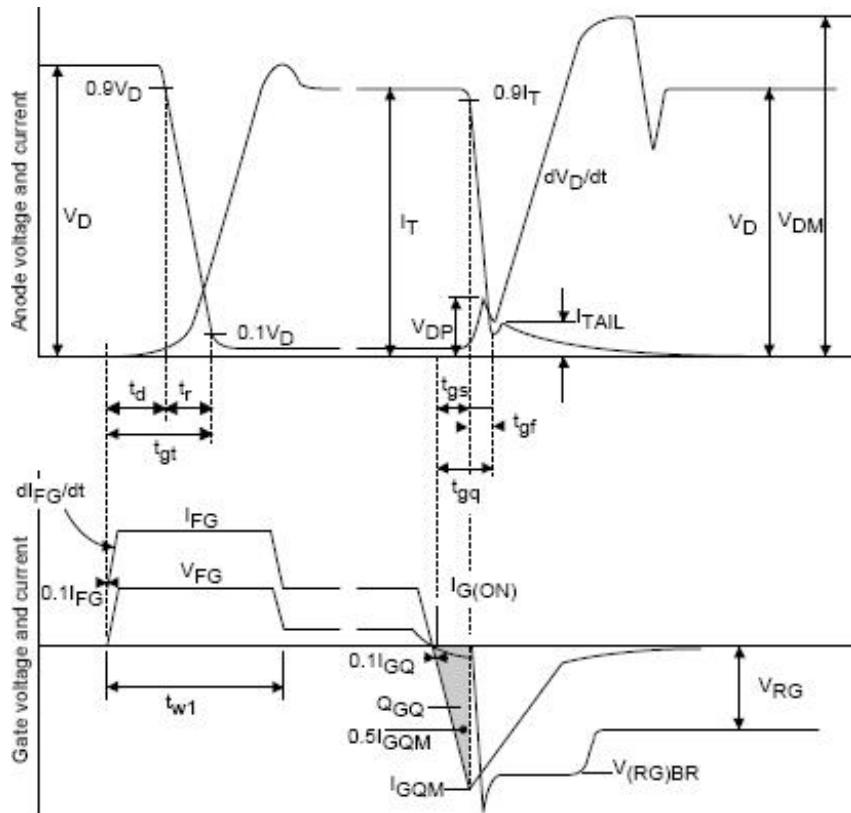


Fig.28 Rate of rise of off-state voltage vs gate cathode resistance



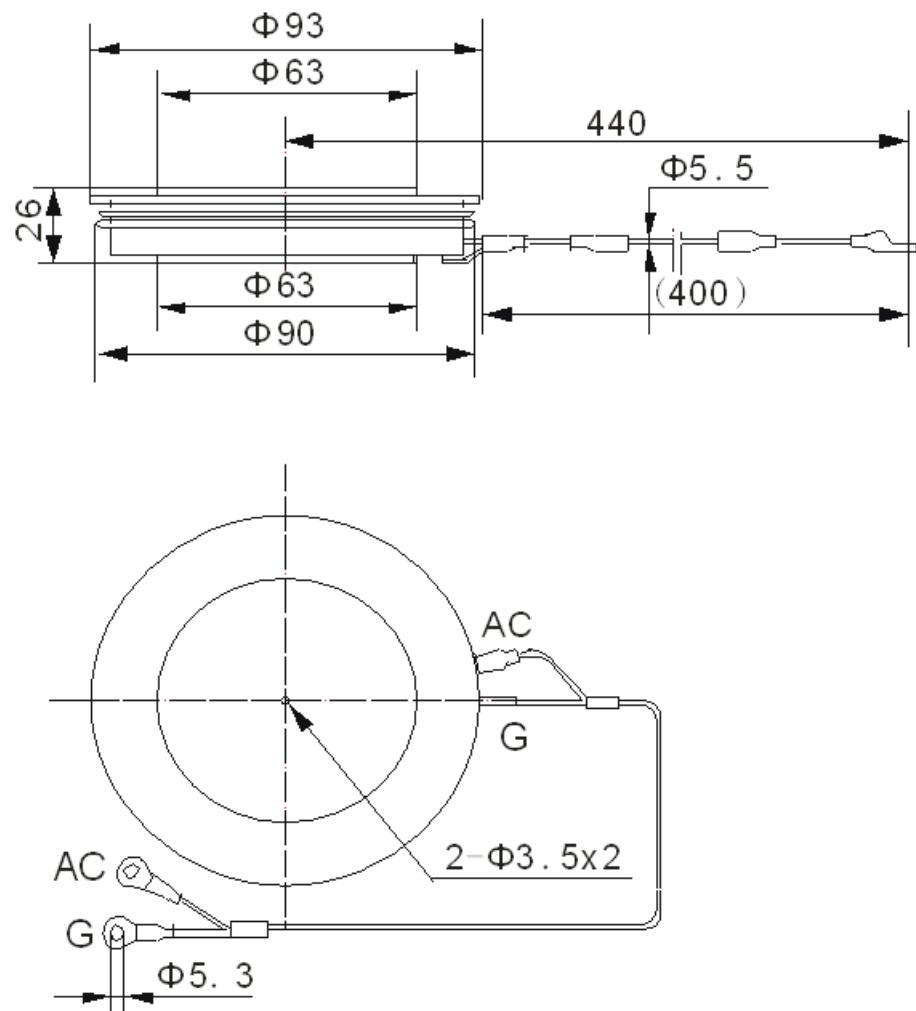
Recommended gate conditions:

$I_{TCM} = 2000A$   
 $I_{FG} = 30A$   
 $I_{G(ON)} = 7A$  d.c.  
 $t_{w1(min)} = 20\mu s$   
 $I_{GQM} = 650 A$   
 $dI_{GQ}/dt = 40A/\mu s$   
 $Q_{GQ} = 6600\mu C$   
 $V_{RG(min)} = 2V$   
 $V_{RG(max)} = 16V$

Fig.29 General switching waveforms

## 产品外形尺寸

All dimensions in mm, unless stated otherwise. DO NOT SCALE.



**Fig.30 Package outline**

Nominal weight: 820g  
Clamping force: 20kN  $\pm 10\%$   
Lead coaxial length: 600mm

**Package outline type code: H**